

TECHNICAL ANNEXES

ANNEX	1	A 61 B	[Project-Rapporteur : 341/AT]	<CE31030E>
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5/04	• --- parts thereof (electrically conductive preparations for use in therapy or testing <u>in vivo</u> A 61 K 50/00)
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N	<i>Heading after 18/00</i>
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Informative note

References listed below indicate IPC places which could also be of interest when carrying out a search in respect of the subject matter covered by the preceding group:

Electrically conductive preparations for use in therapy or testing in vivo, e.g. conductive adhesives or gels to be used with electrodes, [A 61 K 50/00](#).

ANNEX	2	A 61 K	[Project-Rapporteur : 341/AT]	<CE31023E>
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N	50/00	<i>Electrically conductive preparations for use in therapy or testing <u>in vivo</u>, e.g. conductive adhesives or gels to be used with electrodes for electrocardiography (ECG) or for transcutaneous drug administration</i>
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N	<i>Note(s) after 50/00</i>
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Informative notes

References listed below indicate IPC places which could also be of interest when carrying out a search in respect of the subject matter covered by the preceding group:

Electrodes specially adapted for electrocardiography [A 61 B 5/0408](#)

Electrodes specially adapted for foetal cardiography [A 61 B 5/0448](#)

Electrodes specially adapted for electroencephalography [A 61 B 5/0478](#)

Electrodes specially adapted for electromyography [A 61 B 5/0492](#)

Electrodes for electrotherapy [A 61 N 1/04](#).

ANNEX 3 A 61 L [Project-Rapporteur : 341/AT] <CE31031E>

- 15/58 • • • Adhesives (electrically conductive adhesives for use in therapy or testing in vivo [A 61 K 50/00](#))
- 24/00** – – – **colostomy devices** (electrically conductive adhesives for use in therapy or testing in vivo [A 61 K 50/00](#))

ANNEX 4 A 61 N [Project-Rapporteur : 341/AT] <CE31024E>

- 1/00** – – – irradiation apparatus [5/00](#); electrically conductive preparations for use in therapy or testing in vivo [A 61 K 50/00](#))

ANNEX 5 B 02 C [Project-Rapporteur : 346/AT] <CE31002E>

- D 18/40 (covered by [18/00](#) - [18/38](#))*
- D 18/42 (covered by [18/00](#), [E 03 C 1/266](#))*
- D 18/44 (transferred to [B 29 B 17/04](#), covered by [18/00](#))*
- D 19/12 (covered by [19/00](#))*
- D 19/14 (covered by [19/00](#))*

ANNEX 6 B 29 B [Project-Rapporteur : 346/AT] <CE31003E>

- N 17/04 • *Disintegrating plastics* ([9/02](#), [11/02](#), [13/10](#) take precedence)*

ANNEX 7 B 60 R [Project-Rapporteur : 354/DE] <CE31007E>

- N 21/013 • • *including means for detecting collisions, impending collisions or roll-over**
- N 21/0132 • • • *responsive to vehicle motion parameters**
- N 21/0134 • • • *responsive to imminent contact with an obstacle**
- N 21/0136 • • • *responsive to actual contact with an obstacle**

- N 21/015 • • *including means for detecting the presence or position of passengers, passenger seats or child seats, e.g. for disabling triggering*
- N 21/017 • • *including arrangements for providing electric power to the safety arrangements*
- 21/16 • • *--- impact, e.g. air bags (connection of ---*
- C 21/20 • • • *Arrangements for storing inflatable members in their non-use or deflated condition; Arrangement or mounting of air bag modules or components*
- N 21/203 • • • • *in steering wheels or steering columns*
- N 21/205 • • • • *in dashboards*
- N 21/207 • • • • *in vehicle seats*
- N 21/210 • • • • *in vehicle side panels, e.g. doors or pillars*
- N 21/213 • • • • *in vehicle roofs, e.g. in roof frames*
- N 21/215 • • • • *characterised by the covers for the inflatable member*
- N 21/217 • • • • *Inflation fluid source retainers, e.g. reaction canisters; Connection of bags, diffusers or inflation fluid sources thereto*
- D 21/22 *(transferred to 21/20, 21/231)*
- N 21/23 • • • *Inflatable members*
- N 21/231 • • • • *characterised by their shape, e.g. shaped with respect to a specific part of the occupant's body (21/233 takes precedence)*
- N 21/233 • • • • *comprising a plurality of individual compartments; comprising two or more bag-like members, one within the other*
- N 21/235 • • • • *characterised by their material*
- N 21/237 • • • • *characterised by the way they are folded*
- N 21/239 • • • • *characterised by their venting means*
- D 21/24 *(transferred to 21/233)*
- 21/26 • • • *characterised by the inflation fluid source or means to control inflation fluid flow*
- N 21/264 • • • • *using instantaneous generation of gas (21/268 takes precedence)*
- N 21/268 • • • • *using instantaneous release of stored pressurised gas*
- N 21/272 • • • • • *with means for increasing the pressure of the gas when inflation is required, e.g. hybrid inflators*

- N* 21/276 • • • • *with means to vent the inflation fluid source, e.g. in case of overpressure*
- D* 21/28 (*transferred to 21/239, 21/276*)
- D* 21/32 (*covered by 21/16*)
- N* 21/33 • • • *Arrangements for non-electric triggering of inflation (electrical circuits for triggering safety arrangements 21/01)*

ANNEX 8 B 61 L [Project-Rapporteur : 389/RU] <CE31051E>

- C* 23/18 • • • *specially adapted for maintaining a safe distance between vehicles or vehicle trains depending upon speed ---*
- 23/34 • *for indicating the ---*

ANNEX 9 B 65 G [Project-Rapporteur : 358/AT] <CE31009E>

- C* 69/28 • *Loading ramps; Loading docks (as road ---*
- N* 69/30 • • *Non-permanently installed loading ramps, e.g. transportable*
- N* 69/32 • • *Shelters, surrounds or sealing arrangements for loading docks*
- N* 69/34 • • *Accessories, e.g. vehicle restrainers, wheel blockers, positioners or bumpers*

ANNEX 9 B 65 G [Project-Rapporteur : 408/NO] <CE31039E>

- C* 49/07 • • *for semiconductor wafers (specially adapted for conveying of semiconductor wafers during manufacture or treatment of semiconductor or electric solid state devices or components H 01 L 21/677)*

ANNEX 10 B 66 D [Project-Rapporteur : 367/DE] <CE31045E>

Title --- for lifts B 66 B; hoisting devices specially adapted for suspended scaffolds E 04 G 3/32)

ANNEX 11 B 66 F [Project-Rapporteur : 367/DE] <CE31046E>

Title --- with lifting devices E 04 G 1/22, 3/28; lifting devices for ---

ANNEX 12 C 09 J [Project-Rapporteur : 341/AT] <CE31032E>

9/02 • Electrically-conducting adhesives (electrically conductive adhesives specially adapted for use in therapy or testing *in vivo* A 61 K 50/00)

ANNEX 13 E 03 C [Project-Rapporteur : 346/AT] <CE31004E>

1/26 • • --- devices for waste pipes or outlets (1/28 ---

1/266 • • • Arrangement of disintegrating apparatus in waste pipes or outlets; Disintegrating apparatus specially adapted for installation in waste pipes or outlets

N Note(s) after
1/266

Informative note

References listed below indicate IPC places which could also be of interest when carrying out a search in respect of the subject matter covered by the preceding group:

Disintegrating apparatus in general B 02 C.

ANNEX 14 E 04 F [Project-Rapporteur : 366/DE] <CE31011E>

N 13/07 • *composed of covering or lining elements; Sub-structures therefor; Fastening means therefor*

- N 13/072 • • *composed of specially adapted, structured or shaped covering or lining elements*
- N 13/073 • • • *for particular building parts, e.g. corners or columns*
- N 13/074 • • • *for accommodating service installations or utility lines, e.g. heating conduits, electrical lines, lighting devices or service outlets*
- N 13/075 • • • *for insulation or surface protection, e.g. against noise or impact*
- N 13/076 • • • *characterised by the joints between neighbouring elements, e.g. with joint fillings or with tongue and groove connections*
- N 13/077 • • • *composed of several layers, e.g. sandwich panels (13/075 takes precedence)*
- N 13/078 • • • *Stretched foil- or web-like elements attached with edge gripping devices*
- C 13/08 • • *composed of a plurality of similar covering or lining elements (13/072 takes precedence; borders, skirtings 19/02)*
- N Note(s)
before 13/09
- Group 13/09 takes precedence over groups 13/10 to 13/18.*
- N 13/09 • • • *of elements attached to a common web, support plate or grid*
- C 13/10 <Add 1 dot>
- C 13/12 <Add 1 dot>
- C 13/14 • • • *of stone or stone-like materials, e.g. ceramics; of glass*
- N 13/15 • • • • *characterised by the use of glass elements*
- C 13/16 • • • *of fibres or chips, e.g. bonded with synthetic resins*
- C 13/18 <Add 1 dot>
- N 13/20 • • *Fastening means specially adapted for covering or lining elements*
- N 13/22 • • • *Anchors, support angles or consoles*
- N 13/23 • • • • *adjustable*
- N 13/24 • • • *Hidden fastening means on the rear of the covering or lining elements (13/30 takes precedence)*
- N 13/25 • • • • *adjustable*

- N 13/26 • • • *Edge engaging fastening means, e.g. clamps, clips or border profiles*
- N 13/28 • • • • *adjustable*
- N 13/30 • • • *Magnetic fastening means*
- 19/02 <Unchanged>

ANNEX 15 E 06 C [Project-Rapporteur : 367/DE] <CE31052E>

7/42 • – – – therefor (for scaffold elements [E 04 G 5/02](#))

ANNEX 16 F 16 B [Project-Rapporteur : 366/DE] <CE31012E>

Note(s) after the title

N <== for roof drainage

[E 04 F 13/20](#) *Fastening means specially adapted for covering or lining elements for buildings*

[E 04 G 5/04](#) *Fastening scaffolds ==>*

ANNEX 17 G 01 M [Project-Rapporteur : 419/RU] <CE31019E>

15/00 – – – of engines

N *Note(s) after 15/00*

Informative note

References listed below indicate IPC places which could also be of interest when carrying out a search in respect of the subject matter covered by the preceding group:

Measurement of mechanical vibrations in general
[G 01 H](#)

Analysing gases in general [G 01 N](#)

*Arrangements for testing electrical properties;
 Arrangements for locating electric faults; Arrangements for electrical testing characterised by what is being tested not provided for elsewhere* [G 01 R 31/00](#).

- N 15/02 • *Details or accessories of testing apparatus*
- N 15/04 • *Testing of internal-combustion engines, e.g. diagnostic testing of piston engines*
- N *Note(s) after 15/04*

Informative note

References listed below indicate IPC places which could also be of interest when carrying out a search in respect of the subject matter covered by the preceding group:

Monitoring or diagnostic devices for exhaust-gas treatment apparatus [F 01 N 11/00](#)

Indicating or supervising devices of internal-combustion engines [F 02 B 77/08](#)

Running in of internal-combustion engines [F 02 B 79/00](#)

Controlling combustion engines [F 02 D](#)

Apparatus for testing, tuning or synchronising carburettors, e.g. carburettor flow stands [F 02 M 19/01](#)

Testing fuel-injection apparatus [F 02 M 65/00](#)

Testing internal-combustion engine ignition, e.g. timing [F 02 P 17/00](#)

Devices for determining the value of power, e.g. by measuring and simultaneously multiplying the values of torque and revolutions per unit of time, by multiplying the values of tractive or propulsive force and velocity [G 01 L 3/24](#)

Determining the characteristic of torque in relation to revolutions per unit of time [G 01 L 5/26](#)

Devices for detecting or indicating knocks in internal-combustion engines [G 01 L 23/22](#)

Devices for measuring pressure in inlet or exhaust ducts of internal combustion engines [G 01 L 23/24](#)

Means for indicating positions of pistons or cranks of internal-combustion engines by measuring pressure [G 01 L 23/30](#).

	Note(s) before 15/05	<Delete new entry>
N	15/05	<ul style="list-style-type: none">• • <i>by combined monitoring of two or more different engine parameters</i>
N	Note(s) after 15/05	
		<i>Group 15/05 takes precedence over groups 15/06 to 15/12.</i>
N	15/06	<ul style="list-style-type: none">• • <i>by monitoring positions of pistons or cranks</i>
N	15/08	<ul style="list-style-type: none">• • <i>by monitoring pressure in cylinders</i>
N	15/09	<ul style="list-style-type: none">• • <i>by monitoring pressure in fluid ducts, e.g. in lubrication or cooling parts</i>
N	15/10	<ul style="list-style-type: none">• • <i>by monitoring exhaust gases</i>
N	15/11	<ul style="list-style-type: none">• • <i>by detecting misfire</i>
N	15/12	<ul style="list-style-type: none">• • <i>by monitoring vibrations</i>
N	15/14	<ul style="list-style-type: none">• <i>Testing of gas-turbine plants or jet-propulsion plants</i>
N	Note(s) after 15/14	

Informative note

References listed below indicate IPC places which could also be of interest when carrying out a search in respect of the subject matter covered by the preceding group:

Rocket-engine plants characterised by specially adapted arrangements for testing or measuring [F 02 K 9/96](#).

ANNEX	18	G 06 F	[Project-Rapporteur : 406/EP]	<CE31033E>
	11/00	--- static stores G 11 C 29/00 ; coding, decoding ---		
C	17/50	<ul style="list-style-type: none">• <i>Computer-aided design (for the design of test circuits for static stores G 11 C 29/54)</i>		

Note(s) after
 the title

- | | | |
|---|---------|--|
| N | (3) | <i>In this subclass, the following terms are used with the meaning indicated:</i> |
| N | | – "storage element" is an element which can hold at least one item of information and is provided with means for writing-in or reading-out this information; |
| N | | – "memory" is a device, including storage elements, which can hold information to be extracted when desired. |
| | | <Delete former note (3)> |
| | 11/4078 | • • • • • --- Test cells (protection of memory contents during checking or testing 29/52) |
| C | 29/00 | Checking stores for correct operation; Testing stores during standby or offline operation |
| N | 29/02 | • Detection or location of defective auxiliary circuits, e.g. defective refresh counters |
| N | 29/04 | • Detection or location of defective memory elements |
| N | 29/06 | • • Acceleration testing |
| N | 29/08 | • • Functional testing, e.g. testing during refresh, power-on self testing (POST) or distributed testing |
| N | 29/10 | • • • Test algorithms, e.g. memory scan (MScan) algorithms; Test patterns, e.g. checkerboard patterns |
| N | 29/12 | • • • Built-in arrangements for testing, e.g. built-in self testing (BIST) |
| N | 29/14 | • • • • Implementation of control logic, e.g. test mode decoders |
| N | 29/16 | • • • • • using microprogrammed units, e.g. state machines |
| N | 29/18 | • • • • Address generation devices; Devices for accessing memories, e.g. details of addressing circuits |
| N | 29/20 | • • • • • using counters or linear-feedback shift registers (LFSR) |
| N | 29/22 | • • • • • Accessing serial memories |

- N 29/24 • • • • • *Accessing extra cells, e.g. dummy cells or redundant cells*
- N 29/26 • • • • • *Accessing multiple arrays (29/24 takes precedence)*
- N 29/28 • • • • • • *Dependent multiple arrays, e.g. multi-bit arrays*
- N 29/30 • • • • • *Accessing single arrays*
- N 29/32 • • • • • • *Serial access; Scan testing*
- N 29/34 • • • • • • *Accessing multiple bits simultaneously*
- N 29/36 • • • • • *Data generation devices, e.g. data inverters*
- N 29/38 • • • • • *Response verification devices*
- N 29/40 • • • • • • *using compression techniques*
- N 29/42 • • • • • • *using error correcting codes (ECC) or parity check*
- N 29/44 • • • • • *Indication or identification of errors, e.g. for repair*
- N 29/46 • • • • • *Test trigger logic*
- N 29/48 • • • *Arrangements in static stores specially adapted for testing by means external to the store, e.g. using direct memory access (DMA) or using auxiliary access paths (external testing equipment 29/56)*
- N 29/50 • • *Marginal testing, e.g. race, voltage or current testing*
- N 29/52 • *Protection of memory contents; Detection of errors in memory contents*
- N 29/54 • *Arrangements for designing test circuits, e.g. design for test (DFT) tools*
- N 29/56 • *External testing equipment for static stores, e.g. automatic test equipment (ATE); Interfaces therefor*

ANNEX	20	G 21 B	[Project-Rapporteur : 421/RU]	<CE31021E>
<i>C</i>	<i>1/00</i>	<i>Thermonuclear fusion reactors</i>		
<i>N</i>	<i>1/01</i>	• <i>Hybrid fission-fusion nuclear reactors</i>		
<i>D</i>	<i>1/02</i>	<i>(transferred to 1/00, 3/00)</i>		
<i>N</i>	<i>1/03</i>	• <i>with inertial plasma confinement</i>		
<i>N</i>	<i>1/05</i>	• <i>with magnetic or electric plasma confinement</i>		

- N 1/11 • *Details*
- N 1/13 • • *First wall; Blanket; Divertor*
- N 1/15 • • *Particle injectors for producing thermonuclear fusion reactions, e.g. pellet injectors*
- N 1/17 • • *Vacuum chambers; Vacuum systems*
- N 1/19 • • *Targets for producing thermonuclear fusion reactions*
- N 1/21 • • *Electric power supply systems, e.g. for magnet systems*
- N 1/23 • • *Optical systems, e.g. for irradiating targets, for heating plasma or for plasma diagnostics*
- N 1/25 • *Maintenance, e.g. repair or remote inspection*
- N 3/00 ***Low temperature nuclear fusion reactors, e.g. alleged cold fusion reactors***

ANNEX 21 G 21 C [Project-Rapporteur : 421/RU] <CE31034E>

Title --- G 06 G 7/54; fusion reactors, hybrid fission-fusion reactors
 G 21 B; ---

ANNEX 22 H 01 B [Project-Rapporteur : 407/RU] <CE31017E>

Note(s) after the title <Reinsert original entry >

3/30 • • plastics; resins; waxes

N Note(s) after 3/30

Group 3/47 takes precedence over groups 3/32 to 3/46.

N 3/47 • • • *fibre-reinforced plastics, e.g. glass-reinforced plastics*

C 3/48 • • *fibrous materials (fibre-reinforced plastics 3/47)*

ANNEX 23 H 01 L [Project-Rapporteur : 408/NO] <CE31038E>

Note(s) after
 the title

- (2) --- with the meaning indicated:
- N
- "wafer" means a slice of semiconductor or crystalline substrate material, which can be modified by impurity diffusion (doping), ion implantation or epitaxy, and whose active surface can be processed into arrays of discrete components or integrated circuits;
 - "solid state body" ==>

Note(s) after
 21/00

- 21/02 to 21/67.
- N 21/67
- Apparatus specially adapted for handling semiconductor or electric solid state devices during manufacture or treatment thereof; Apparatus specially adapted for handling wafers during manufacture or treatment of semiconductor or electric solid state devices or components
- N 21/673
- • using specially adapted carriers
- N 21/677
- • for conveying, e.g. between different work stations
- C 21/68
- • for positioning, orientation or alignment (for conveying 21/677)
- N 21/683
- • for supporting or gripping (for conveying 21/677, for positioning, orientation or alignment 21/68)
- N 21/687
- • • using mechanical means, e.g. chucks, clamps or pinches

ANNEX 23 H 01 L [Project-Rapporteur : 423/DE] <CE31040E>

- C 21/00
- Processes or apparatus specially adapted for** --- (processes or apparatus specially adapted for the manufacture --- 31/00 to 51/00 or of ---
- C 21/02
- --- parts thereof
- C 21/64
- --- thereof, not specially adapted for a single type of device provided --- 31/00 to 51/00

Note(s) after
23/00

- <== by that group;
- --- 31/00 to 51/00, which details ---

- C 25/03 • --- 27/00 to 51/00, e.g. assemblies ---
- C 25/16 • --- 27/00 to 51/00, e.g. forming ---
- C 25/18 • --- 27/00 to 51/00
- C 27/00 --- or apparatus specially adapted for --- 31/00 to 51/00; details thereof 23/00, 29/00 to 51/00; assemblies consisting ---

Note(s) after
27/00

(1) In this group, in the absence ---

- 27/02 • including semiconductor components specially adapted for rectifying, oscillating, amplifying or switching and having at least one potential-jump barrier or surface barrier; including integrated ---
- 27/14 • --- electromagnetic radiation of shorter wavelength or corpuscular radiation and specially adapted either for the conversion ---
- 27/15 • --- or surface barrier, specially adapted for ---
- N 27/28 • including components using organic materials as the active part, or using a combination of organic materials with other materials as the active part
- N 27/30 • • with components specially adapted for sensing infra-red radiation, light, electromagnetic radiation of shorter wavelength, or corpuscular radiation; with components specially adapted for either the conversion of the energy of such radiation into electrical energy or for the control of electrical energy by such radiation
- N 27/32 • • with components specially adapted for light emission, e.g. flat-panel displays using organic light-emitting diodes
- 29/00 **Semiconductor devices specially adapted for rectifying, amplifying, oscillating or switching and having at least one potential-jump barrier or surface barrier; Capacitors or resistors with --- to 47/00, 51/05 take precedence; processes or apparatus specially adapted for the ---**
- C 31/00 --- radiation and specially adapted either --- or apparatus specially adapted for the manufacture --- Details thereof (51/42 takes precedence; ---
- 31/12 • --- surface barrier specially adapted for ---

- 31/18 • Processes or apparatus specially adapted for the manufacture – – – parts thereof (for manufacture or treatment of semiconductor or solid state devices or of parts thereof in general 21/00)
- C 33/00 – – – *surface barrier specially adapted for – – – or apparatus specially adapted for the manufacture – – – Details thereof (51/50 takes precedence; devices consisting of a plurality of components formed in or on a common substrate 27/00; couplings of light guides – – –*
- 35/00 – – – **or apparatus specially adapted for the manufacture – – –**
- 35/34 • Processes or apparatus specially adapted for the manufacture – – – parts thereof (for manufacture or treatment of semiconductor or solid state devices or of parts thereof in general 21/00)
- 37/00 – – – **or apparatus specially adapted for the manufacture – – –**
- 39/00 – – – **or apparatus specially adapted for the manufacture – – –**
- 39/24 • Processes or apparatus specially adapted for the manufacture – – – parts thereof (for manufacture or treatment of semiconductor or solid state devices or of parts thereof in general 21/00; magnetic – – –
- 41/00 – – – **or apparatus specially adapted for the manufacture – – –**
- 41/22 • Processes or apparatus specially adapted for the manufacture – – – parts thereof (for manufacture or treatment of semiconductor or solid state devices or of parts thereof in general 21/00)
- 43/00 – – – **or apparatus specially adapted for the manufacture – – –**
- 43/12 • Processes or apparatus specially adapted for the manufacture – – – parts thereof (for manufacture or treatment of semiconductor or solid state devices or of parts thereof in general 21/00)
- 45/00 **Solid state devices specially adapted for – – – or apparatus specially adapted for the manufacture – – –**
- 47/00 – – – **or apparatus specially adapted for the manufacture – – –**
- C 49/00 – – – 47/00 and 51/00 and not provided for in any – – – or apparatus specially adapted for the manufacture – – –
- C 51/00 **Solid state devices using organic – – – with other materials as the active part; Processes – – – parts thereof** (devices consisting of a plurality of components formed in or on a common substrate 27/28; thermoelectric devices using organic material 35/00, 37/00; piezoelectric, electrostrictive or magnetostrictive elements using organic material 41/00)
- N 51/05 • specially adapted for rectifying, amplifying, oscillating or switching and having at least one potential-jump barrier or surface barrier; Capacitors or resistors with at least one potential-jump barrier or surface barrier
- C 51/10 <Add 1 dot>

- D 51/20 (transferred to 51/05, 51/42, 51/50)
- C 51/30 <Add 1 dot>
- C 51/40 • --- treatment of such devices or ---
- N 51/42 • specially adapted for sensing infra-red radiation, light, electromagnetic radiation of shorter wavelength, or corpuscular radiation; specially adapted either for the conversion of the energy of such radiation into electrical energy or for the control of electrical energy by such radiation
- N 51/44 • • Details of devices
- N 51/46 • • Selection of materials
- N 51/48 • • Processes or apparatus specially adapted for the manufacture or treatment of such devices or of parts thereof
- N 51/50 • specially adapted for light emission, e.g. organic light emitting diodes (OLED) or polymer light emitting devices (PLED) (organic semiconductor lasers [H 01 S 5/36](#))
- N 51/52 • • Details of devices
- N 51/54 • • Selection of materials (organic luminescent materials [C 09 K 11/06](#))
- N 51/56 • • Processes or apparatus specially adapted for the manufacture or treatment of such devices or of parts thereof

ANNEX	24	H 01 S	[Project-Rapporteur : 423/DE]	<CE31041E>
	5/30		• --- region; Materials used for the active region	
	5/32		• • --- double- hetero-structures (5/34 , 5/36 take precedence)	
	5/34		• • --- lasers (GRINSCH-lasers) (5/36 takes precedence)	
N	5/36		• • comprising organic materials (dye lasers 3/213)	

ANNEX	25	H 05 B	[Project-Rapporteur : 423/DE]	<CE31042E>
C	33/00		--- light emission H 01 L 27/15 , 33/00 ; organic light emitting devices H 01 L 27/32 , 51/50 ; lasers H 01 S 3/00 , 5/00 ; compositions per se, see the ---	

ANNEX	26	H 05 H	[Project-Rapporteur : 421/RU]	<CE31022E>
Title		PLASMA TECHNIQUE (ion-beam tubes H 01 J 27/00 ; – – –		
1/00		Generating plasma; Handling plasma (application of plasma technique in thermonuclear fusion reactors G 21 B 1/00)		

[End of Technical Annexes and of document]